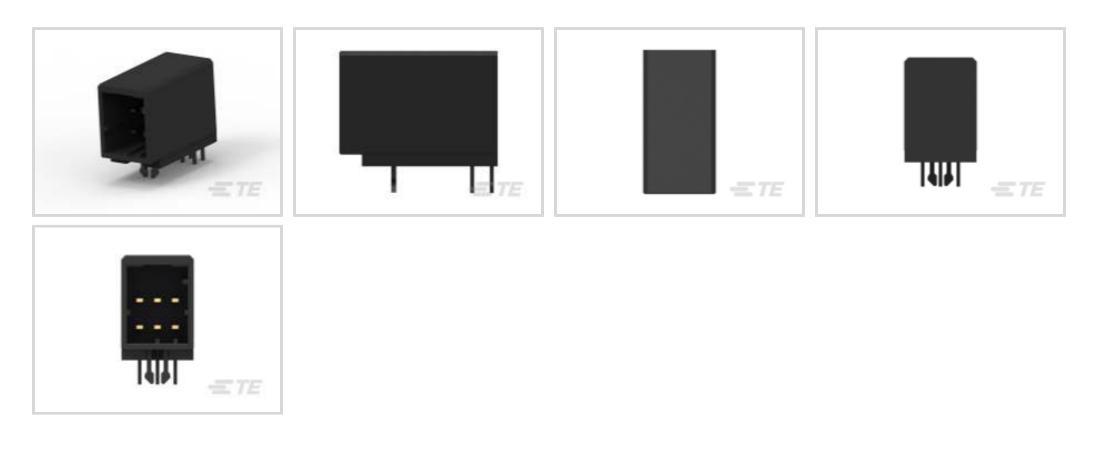
# 1376136-2 - ACTIVE

### Dynamic Series | Dynamic 2000 Series

TE Internal #: 1376136-2 PCB Mount Header, Horizontal, Wire-to-Board, 6 Position, 2.5 mm [. 099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series

#### View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 5A, gold plated



Connector System: Wire-to-Board Number of Positions: 6

Number of Rows: 2

Centerline (Pitch): 2.5 mm [.099 in ]

PCB Mount Orientation: Horizontal

### All Header Assembly: Wire-to-Board, 5A, gold plated (44)



## Features

### Product Type Features

Connector System	Wire-to-Board							
Header Type	Fully Shrouded							
Sealable	No							
Connector & Contact Terminates To	Printed Circuit Board							
PCB Connector Assembly Type	PCB Mount Header							
Configuration Features								
Number of Positions	6							
Number of Rows	2							
PCB Mount Orientation	Horizontal							
Body Features								
Primary Product Color	Black							
Contact Features								

PCB Mount Header, Horizontal, Wire-to-Board, 6 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series



Contact Mating Area Plating Material Thickness	.38 μm[15 μin]								
Contact Mating Area Plating Material	Gold								
Contact Type	Pin								
Contact Current Rating (Max)	5 A								
Termination Features									
Termination Method to Printed Circuit Board	Through Hole - Solder								
Mechanical Attachment									
Mating Alignment Type	Polarization								
Mating Retention	With								
PCB Mount Retention Type	Retention Leg								
Connector Mounting Type	Board Mount								
Mating Alignment	With								
PCB Mount Alignment	Without								
PCB Mount Retention	With								
Housing Features									
Housing Material	Polyester GF								
Centerline (Pitch)	2.5 mm[.099 in]								

## Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]							
Operation/Application								
Circuit Application	Power & Signal							
Industry Standards								
UL Flammability Rating	UL 94V-0							
Packaging Features								
Packaging Type	Box, Tube							
Product Compliance For compliance documentation, visit the product page on TE.com>								
EU RoHS Directive 2011/65/EU	Compliant							
EU ELV Directive 2000/53/EC	Compliant							
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold							
EU REACH Regulation (EC) No. 1907/2006								

PCB Mount Header, Horizontal, Wire-to-Board, 6 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series



Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC

Not Low Halogen - contains Br or Cl > 900 ppm.

Wave solder capable to 265°C

Halogen Content

Solder Process Capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

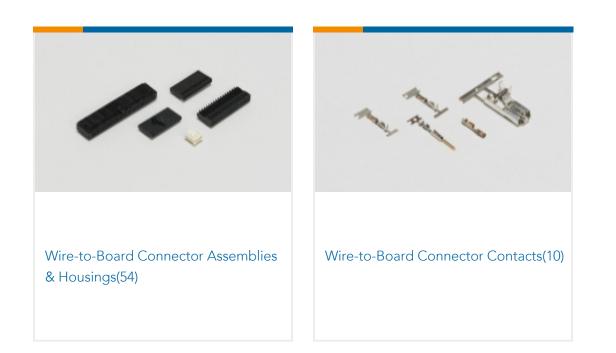


## Also in the Series | Dynamic 2000 Series



PCB Mount Header, Horizontal, Wire-to-Board, 6 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series





## Customers Also Bought



E STACK PIANO 4P G LONG T&R PD	RQ 0805 90R9 0.1% 10PPM 5K RL	SUPER SEAL 60POS CAP ASSY H AU	070 MULTILOCK CAP ASSY 18P
ON			

## Documents

Product Drawings DYNAMIC D2100 HDR H ASSY 6P Y

English

## CAD Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_1376136-2\_E.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_1376136-2\_E.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_1376136-2\_E.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

**C** For support call+1 800 522 6752

PCB Mount Header, Horizontal, Wire-to-Board, 6 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series



Datasheets & Catalog Pages 1-1773732-4\_DYNAMIC\_SERIES\_CATALOG\_ENGLISH

Japanese

1-1773732-4\_DYNAMIC\_SERIES\_CATALOG\_ENGLISH

English

**Product Specifications** 

Dynamic Connector D-2000 Series

Japanese

**Application Specification** 

Japanese

Product Environmental Compliance MD\_1376136-2\_1110201764\_dmtec

English

MD\_1376136-2\_1110201764\_dmtec

English

Agency Approvals Agency Approval Document English